

RF5122 3V TO 4.5V, 2.4GHz TO 2.5GHz LINEAR POWER AMPLIFIER

RoHS Compliant & Pb-Free Product Package Style: QFN, 8-Pin, 2.2mmx2.2mmx0.6mm

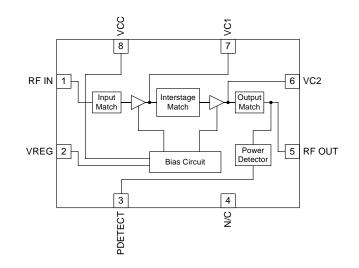


Features

- Single Power Supply 3.0V to 3.6V
- 24dB Minimum Gain
- \bullet Input and Output Matched to 50Ω
- 2400 MHz to 2500 MHz Frequency Range
- +18dBm @ <2.5% typ EVM, 120mA @ 3.3V_{CC}

Applications

- IEEE802.11b/g/n WLAN Applications
- 2.5GHz ISM Band Applications
- Commercial and Consumer Systems
- Portable Battery-Powered Equipment
- Spread-Spectrum and MMDS Systems



Functional Block Diagram

Product Description

The RF5122 is a linear, medium-power, high-efficiency, two-stage amplifier IC designed specifically for battery-powered WLAN applications such as PC cards, mini PCI, and compact flash applications. The device is manufactured on an advanced InGaP Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as the final RF amplifier in 2.5GHz OFDM and other spread-spectrum transmitters. The device is provided in a 2.2mmx2.2mm, 8-pin, QFN with a backside ground. The RF5122 is designed to maintain linearity over a wide range of supply voltages and power outputs. The RF5122 also has built-in power detector and incorporates the input, interstage, and output matching components internally which reduces the component count used externally and makes it easier to incorporate on any design.

Ordering Information

RF5122 3V t RF5122PCBA-41X Fully

3V to 4.5V, 2.4GHz to 2.5GHz Linear Power Amplifier Fully Assembled Evaluation Board

Optimum Technology Matching® Applied

🗌 GaAs HBT	□ SiGe BiCMOS	🗌 GaAs pHEMT	🗌 GaN HEMT
□ GaAs MESFET ☑ InGaP HBT	Si BiCMOS	Si CMOS	
InGaP HBT	SiGe HBT	🗌 Si BJT	

RF MICRO DEVICES®, RFMD®, Optimum Technology Matching®, Enabling Wireless Connectivity^M, PowerStar®, POLARIS^M TOTAL RADIO^M and UltimateBlue^M are trademarks of RFMD, LLC. BLUETOOTH is a trade mark owned by Bluetooth SIG, Inc., U.S.A. and licensed for use by RFMD. All other trade names, trademarks and registered trademarks are the property of their respective owners. @2006. RF Micro Devices. Inc.

Rev A7 DS080103

7628 Thorndike Road, Greensboro, NC 27409-9421. For sales or technical support, contact RFMD at (+1) 336-678-5570 or sales-support@rfmd.com.

RF5122



Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage	-0.5 to +5.0	V _{DC}
Power Control Voltage (V _{REG})	-0.5 to 3.5	V
DC Supply Current	400	mA
Input RF Power	+5	dBm
Operating Ambient Temperature	-30 to +85	°C
Storage Temperature	-40 to +150	°C
Moisture sensitivity	JEDEC Level 2	
ESD HBM	450	V
MM	50	V



Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EUDirective2002/95/EC (at time of this document revision).

The information in this publication is believed to be accurate and reliable. However, no responsibility is assumed by RF Micro Devices, Inc. ("RFMD") for its use, nor for any infringement of patents, or other rights of third parties, resulting from its use. No license is granted by implication or otherwise under any patent or patent rights of RFMD. RFMD reserves the right to change component circuitry, recommended application circuitry and specifications at any time without prior notice.

Devenetar	Specification		11	Condition		
Parameter	Min.	in. Typ. Max.		Unit	Condition	
Overall					$\label{eq:constraint} \begin{array}{l} \mbox{Temperature} = +25\ ^\circ\mbox{C}, \ V_{CC} = 3.3\ V, \\ V_{REG} = 2.8\ V \ \mbox{pulsed at }1\% \ \mbox{to }100\% \ \mbox{duty cycle}, \\ \mbox{Frequency} = 2450\ \mbox{MHz}, \\ \mbox{circuit per evaluation board schematic, unless} \\ \mbox{otherwise specified} \end{array}$	
Frequency	2.40		2.50	GHz	IEEE802.11g IEEE802.11n	
Output Power	18			dBm	At max data rate, OFDM modulation	
EVM*		2.5	4	%	RMS, mean	
Gain	24	25.5		dB	At +18dBm RF P _{OUT} and 54Mbps	
Gain Variance			1.25	±dB	-30°C to +85°C	
Power Detector						
P _{OUT} =8dBm		0.4	0.7	V		
P _{OUT} =18dBm	1.25	1.35	1.50	V		
Current						
Operating		120	145	mA	At +18dBm RF P _{OUT} and 54Mbps	
Quiescent		85		mA	Data rate @ <u><</u> 3.5% EVM RMS, mean, T=-30 °C to +50 °C	
I _{REG} Current		2		mA	V_{CC} =+3.3 V_{DC}	
Shutdown			10	μΑ		
Power Supply	3.0	3.3	4.5	V _{DC}	Operating Range	
V _{REG1} , V _{REG2} Input Voltage	2.75	2.8	2.9	V _{DC}	Operating Range	
Output VSWR			10:1			
Input Return Loss		-15	-10	dB		
Turn-on Time**		0.5	1.0	μS	Output stable to within 90% of final gain	
Second Harmonic			-27	dBm	Fundamental frequency is between 2400MHz and 2500MHz; RF P _{OUT} =+18dBm. See note 2.	

Notes:

*The EVM specification is obtained with a signal generator that has an EVM floor of less than 0.7%.

**The PA must operate with gated bias voltage input at 1% to 99% duty cycles without any EVM or other parameter degradation.

Note 2: For best harmonic rejection please refer to the harmonic rejection application schematic.

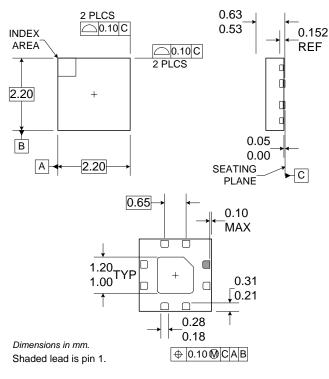
Downloaded from Elcodis.com electronic components distributor



rfmd.com

Pin	Function	Description	Interface Schematic
1	RF IN	RF input. Input is matched to 50Ω and DC block is provided internally.	VCC Interstage Match Match
2	VREG	Bias current control voltage for the first and second amplifier stage.	
3	PDETECT	Power detector which provides an output voltage proportional to the RF output power level. May need external decoupling capacitor for stability. May need external circuitry to bring output voltage to desired level.	
4	N/C	Must be left as no connect, not grounded.	
5	RF OUT	RF output. Output is matched to 50Ω and DC block is provided internally.	VCC2
6	VC2	Voltage supply for the second amplifier stage.	
7	VC1	Voltage supply for the first amplifier stage.	
8	VCC	Supply voltage for the bias reference and control circuit. May be connected with V _{C1} and V _{C2} (with a single supply voltage) as long as V _{CC} does not exceed +4.5V _{DC} in this configuration.	
Pkg Base	GND	The center metal base of the QFN package provides DC and RF ground as well as heat sink for the amplifier.	

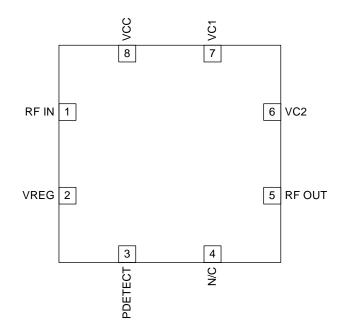
Package Drawing



7628 Thorndike Road, Greensboro, NC 27409-9421 · For sales or technical support, contact RFMD at (+1) 336-678-5570 or sales-support@rfmd.com.



Pin Out



Downloaded from Elcodis.com electronic components distributor





Theory of Operation and Application Information

The RF5122 is a two-stage power amplifier (PA) with a minimum gain of 24dB minimum gain in the 2.4GHz to 2.5GHz ISM band. The RF5122 has integrated input, interstage and output matching components thus allowing minimal bill of material (BOM) parts count in end applications. The RF5122 is designed primarily for IEEE802.11b/g/n WLAN applications where the available supply voltage and current are limited. This amplifier will operate to (and below) the lowest expected voltage made available by a typical PCMCIA slot in a laptop PC, and will maintain required linearity at decreased supply voltages.

The RF5122 requires only a single positive supply of 3.3V nominal (or greater) to operate to full specifications. Power control is provided through one bias control input pin (V_{REG}). DC blocking caps are provided internally and the evaluation board circuit (available from RF Micro Devices, Inc. (RFMD)) is optimized for 3.3V_{DC} applications.

For best results, the PA circuit layout from the evaluation board should be copied as closely as possible, particularly the ground layout and ground vias. Pin 4 *must* be left as a no-connect on the PCB in order for the PA to work properly. Other configurations may also work, but the design process is much easier and quicker if the layout is copied from the RF5122 evaluation board. Gerber files of RFMD PCBA designs can be provided on request. The RF5122 is a very easy part to implement, but care in circuit layout and component selection is always advisable when designing circuits to operate at 2.5 GHz. The RF5122 evaluation board layout and schematic are available using 0201 (US) size components which will help shrink the overall size of the total area of the PA and components of the intended design. Please contact RFMD Sales or Application Engineering for additional data and guidance.

For best performance, it is important to duplicate (as closely as possible) the layout of the evaluation board. The RF5122 has primarily been characterized with a voltage on V_{REG} of $2.8V_{DC}$. If you prefer to use a control voltage that is significantly different than $2.8V_{DC}$, or a different frequency than the recommended frequency range, contact RFMD Sales or Applications Engineering for additional data and guidance.

Package Type	Length (mm)	Width (mm)	Area (mm ²)	Delta (Δ) (mm ²) to QFN8		
SOT 23-6	3.1	3.0	9.30	4.46		
QFN12	3.0	3.0	9.00	4.16		
SOT 23-5	2.9	2.8	8.12	3.28		
QFN8	2.2	2.2	4.84	0.00		

QFN8 Package Area versus Other Small Form Factor Package Areas

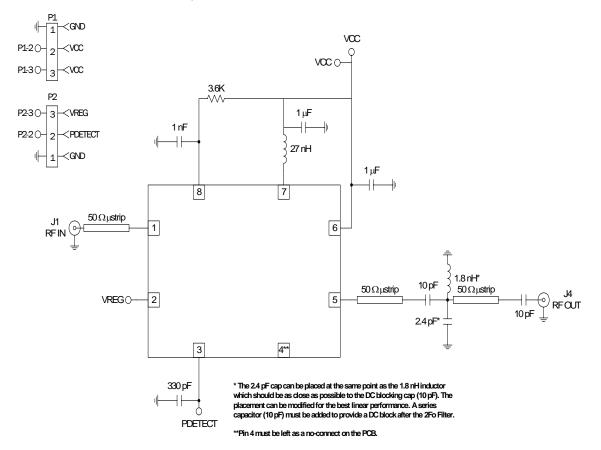
An application schematic for 2.5 GHz operation is included that has two additional components, one shunt inductor, and one shunt capacitor, on the output for improved second harmonic rejection. This layout provides ~20 dB rejection at 5 GHz with a minimal BOM count.





Application Schematic

for Improved Second Harmonic Performance







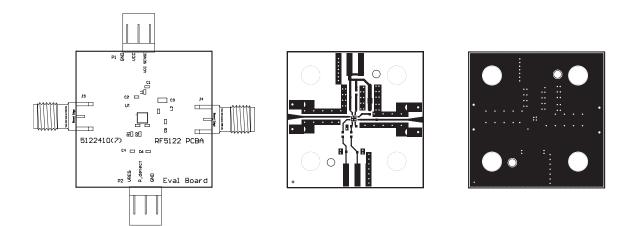
vcc Q <GND 1 C1 <vcc P1-20-2 1 μF P1-30-3 <VCC ┥┝ -||L1 C2 27 nH 1 nF P2-3 ()-<VREG 3 ┥┟ P3-3 O- 2 - PDETECT C3 1 μF <GND ⊪ 1 8 7 L2 ξ 0Ω 50 Ω µstrip J1 6 ်ဝ-1 RF IN Interstage Match Input Match Output Match R1 0Ω 50 Ω µstrip J4 VREG () 2 Power $\wedge \wedge \wedge$ 5 **RF OUT** Detector **Bias Circuit** 3 4 *Pin 4 should be left as a no-connect on the PCB. NOTE: The RF5122 evaluation board layout and schematic are available using 0201 (US) size components which will help shrink the overall size of the total area of the PA and components of this intended design. Please contact RFMD Sales or Application Engineering for R2 C6 $\begin{cases} R2 \\ 0 \Omega \end{cases}$ 330 pF additional data and guidance. PDETECT

Evaluation Board Schematic





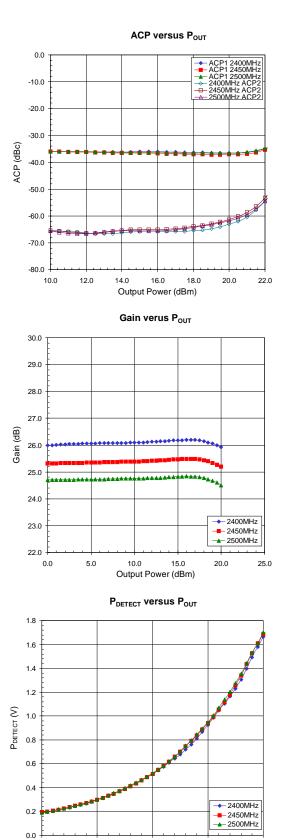
Evaluation Board Layout Board Size 1.0" x 1.0" Board Thickness 0.031"; Board Material FR-4; Multi-Layer





rfmd.com

RFMD 💵

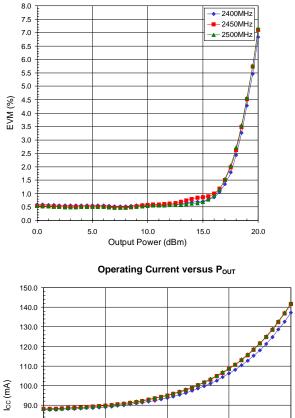


10.0

Output Power (dBm)

15.0

20.0



EVM versus Pout

110.0 100.0 90.0 80.0 70.0 60.0 50.0 100.0

Output Power (dBm)

Rev A7 DS080103

0.0

7628 Thorndike Road, Greensboro, NC 27409-9421 · For sales or technical support, contact RFMD at (+1) 336-678-5570 or sales-support@rfmd.com.

5.0





PCB Design Requirements

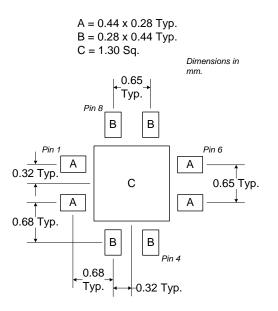
PCB Surface Finish

The PCB surface finish used for RFMD's qualification process is electroless nickel, immersion gold. Typical thickness is 3 µinch to 8 µinch gold over 180 µinch nickel.

PCB Land Pattern Recommendation

PCB land patterns are based on IPC-SM-782 standards when possible. The pad pattern shown has been developed and tested for optimized assembly at RFMD; however, it may require some modifications to address company specific assembly processes. The PCB land pattern has been developed to accommodate lead and package tolerances.

PCB Metal Land Pattern

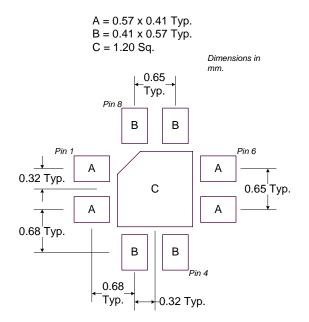






PCB Solder Mask Pattern

Liquid Photo-Imageable (LPI) solder mask is recommended. The solder mask footprint will match what is shown for the PCB metal land pattern with a 2mil to 3mil expansion to accommodate solder mask registration clearance around all pads. The center-grounding pad shall also have a solder mask clearance. Expansion of the pads to create solder mask clearance can be provided in the master data or requested from the PCB fabrication supplier.







RoHS* Banned Material Content

RoHS Compliant:	Yes
Package total weight in grams (g):	0.008
Compliance Date Code:	N/A
Bill of Materials Revision:	-
Pb Free Category:	e3

Bill of Materials	Parts Per Million (PPM)						
	Pb	Cd	Hg	Cr VI	PBB	PB	
Die	0	0	0	0	0		
Molding Compound	0	0	0	0	0		
Lead Frame	0	0	0	0	0		
Die Attach Epoxy	0	0	0	0	0		
Wire	0	0	0	0	0		
Solder Plating	0	0	0	0	0		

This RoHS banned material content declaration was prepared solely on information, including ana data, provided to RFMD by its suppliers, and applies to the Bill of Materials (BOM) revision no

* DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction c use of certain hazardous substances in electrical and electronic equipment